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- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- PNP Inputs Reduce DC Loading
- Hysteresis at Inputs Improves Noise Margins

### description

These octal buffers and line drivers are designed specifically to improve both the performance and density of three-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. The designer has a choice of selected combinations of inverting and noninverting outputs, symmetrical, active-low output-control ( $\overline{G}$ ) inputs, and complementary output-control ( $\overline{G}$  and  $\overline{G}$ ) inputs. These devices feature high fan-out, improved fan-in, and 400-mV noise margin. The SN74LS' and SN74S' devices can be used to drive terminated lines down to 133  $\Omega$ .

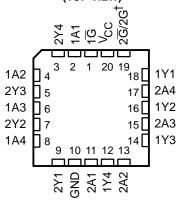
SN54LS', SN54S' . . . J OR W PACKAGE SN74LS240, SN74LS244 . . . DB, DW, N, OR NS PACKAGE SN74LS241 . . . DW, N, OR NS PACKAGE SN74S' . . . DW OR N PACKAGE

(TOP VIEW)

	•	,	
1 <mark>G</mark> [	1	20	V <sub>C</sub> C
1A1 [	2	19	2G/2G†
2Y4 [	1	18	1Y1
1A2 [		17	2A4
2Y3 [		16	1Y2
1A3 [			2A3
2Y2 [	7	14	1Y3
1A4 [	8	13	2A2
2Y1 [	9	12	1Y4
GND [	10	11	2A1

†2G for 'LS241 and 'S241 or 2G for all other drivers.

# SN54LS', SN54S' . . . FK PACKAGE (TOP VIEW)



 $\dagger$  2G for 'LS241 and 'S241 or  $2\overline{G}$  for all other drivers.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



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#### **ORDERING INFORMATION**

TA	PACK	AGET	ORDERABLE PART NUMBER	TOP-SIDE MARKING
			SN74LS240N	SN74LS240N
			SN74LS241N	SN74LS241N
	PDIP – N	Tube	SN74LS244N	SN74LS244N
		rube	SN74S240N	SN74S240N
			SN74S241N	SN74S241N
			SN74S244N	SN74S244N
		Tube	SN74LS240DW	LS240
		Tape and reel	SN74LS240DWR	LS240
		Tube	SN74LS241DW	LS241
		Tape and reel	SN74LS241DWR	LS241
		Tube	SN74LS244DW	LS244
0°C to 70°C	SOIC - DW	Tape and reel	SN74LS244DWR	L3244
	3010 - DW	Tube	SN74S240DW	S240
		Tape and reel	SN74S240DWR	3240
		Tube	SN74S241DW	S241
		Tape and reel	SN74S241DWR	3241
		Tube	SN74S244DW	S244
		Tape and reel	SN74S244DWR	3244
			SN74LS240NSR	74LS240
	SOP – NS	Tube	SN74LS241NSR	74LS241
			SN74LS244NSR	74LS244
	SSOP – DB	Tape and reel	SN74LS240DBR	LS240
	330F - DB	Tape and feet	SN74LS244DBR	LS244

<sup>†</sup>Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



### **ORDERING INFORMATION (CONTINUED)**

TA	PAG	CKAGET	ORDERABLE PART NUMBER	TOP-SIDE MARKING
			SN54LS240J	SN54LS240J
			SNJ54LS240J	SNJ54LS240J
			SN54LS241J	SN54LS241J
			SNJ54LS241J	SNJ54LS241J
			SN54LS244J	SN54LS244J
	CDIP – J	Tube	SNJ54LS244J	SNJ54LS244J
	CDIP = J	Tube	SN54S240J	SN54S240J
			SNJ54S240J	SNJ54S240J
			SN54S241J	SN54S241J
			SNJ54S241J	SNJ54S241J
			SN54S244J	SN54S244J
–55°C to 125°C			SNJ54S244J	SNJ54S244J
-55 C to 125 C			SNJ54LS240W	SNJ54LS240W
			SNJ54LS241W	SNJ54LS241W
	CFP – W	Tube	SNJ54LS244W	SNJ54LS244W
	CFF - W	Tube	SNJ54S240W	SNJ54S240W
			SNJ54S241W	SNJ54S241W
			SNJ54S244W	SNJ54S244W
			SNJ54LS240FK	SNJ54LS240FK
			SNJ54LS241FK	SNJ54LS241FK
	LCCC – FK	Tube	SNJ54LS244FK	SNJ54LS244FK
	LCCC - FK	Tube	SNJ54S240FK	SNJ54S240FK
			SNJ54S241FK	SNJ54S241FK
			SNJ54S244FK	SNJ54S244FK

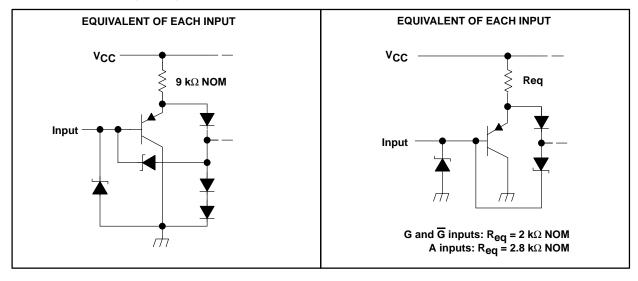
<sup>†</sup> Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

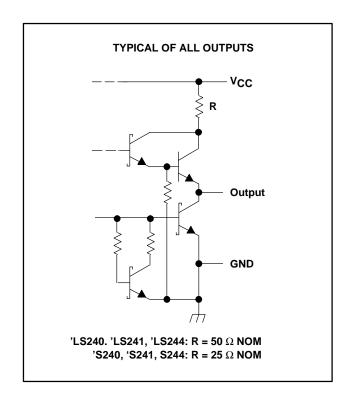


### schematics of inputs and outputs

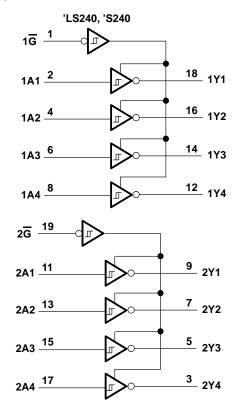
'LS240, 'LS241, 'LS244

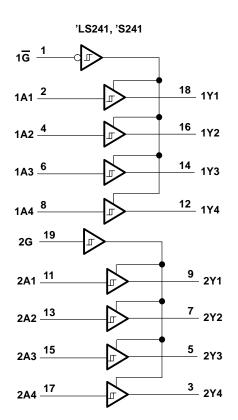
'S240, 'S241, 'S244

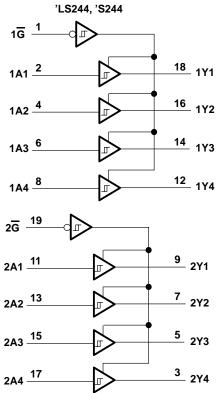




### logic diagram







Pin numbers shown are for DB, DW, J, N, NS, and W packages.

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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage, V <sub>CC</sub> (see Note 1)		7 V
Input voltage, V <sub>I</sub> : 'LS		
'S		5.5 V
Off-state output voltage		5.5 V
Package thermal impedance, θ <sub>JA</sub> (see Note 2)	: DB package	70°C/W
	DW package	58°C/W
	N package	69°C/W
	NS package	60°C/W
Storage temperature range, T <sub>stq</sub>		–65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### recommended operating conditions

		SN54LS'			SN74LS'			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage (see Note 1)	4.5	5	5.5	4.75	5	5.25	V
$V_{IH}$	High-level input voltage	2			2			V
V <sub>IL</sub>	Low-level input voltage			0.7			8.0	V
ЮН	High-level output current			-12			-15	mA
loL	Low-level output current			12			24	mA
TA	Operating free-air temperature	-55		125	0		70	°C

NOTE 1: Voltage values are with respect to network ground terminal.



NOTES: 1. Voltage values are with respect to network ground terminal.

<sup>2.</sup> The package thermal impedance is calculated in accordance with JESD 51-7.

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# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETER			-+		SN54LS'			SN74LS'		
PARAMETER		TEST CONDITION	Sı	MIN	TYP <sup>‡</sup>	MAX	MIN	TYP <sup>‡</sup>	MAX	UNIT
VIK	V <sub>CC</sub> = MIN,	I <sub>I</sub> = -18 mA				-1.5			-1.5	V
Hysteresis (V <sub>T+</sub> – V <sub>T</sub> –)	V <sub>CC</sub> = MIN			0.2	0.4		0.2	0.4		٧
VOH	$V_{CC} = MIN,$ $I_{OH} = -3 \text{ mA}$	V <sub>IH</sub> = 2 V,	V <sub>IL</sub> = MAX,	2.4	3.4		2.4	3.4		V
VOH	$V_{CC} = MIN,$ $I_{OH} = MAX$	V <sub>IH</sub> = 2 V,	V <sub>IL</sub> = 0.5 V,	2			2			V
VOL	V <sub>CC</sub> = MIN,	V <sub>IH</sub> = 2 V,	$I_{OL} = 12 \text{ mA}$			0.4			0.4	V
VOL.	V <sub>IL</sub> = MAX		I <sub>OL</sub> = 24 mA					-	0.5	V
lozh	$V_{CC} = MAX,$ $V_{IL} = MAX$	V <sub>IH</sub> = 2 V,	V <sub>O</sub> = 2.7 V			20			20	μΑ
l <sub>OZL</sub>	V <sub>CC</sub> = MAX, V <sub>IL</sub> = MAX	V <sub>IH</sub> = 2 V,	V <sub>O</sub> = 0.4 V			-20			-20	μΑ
IĮ	$V_{CC} = MAX$ ,	V <sub>I</sub> = 7 V				0.1			0.1	mA
lιΗ	$V_{CC} = MAX$ ,	V <sub>I</sub> = 2.7 V				20			20	μΑ
IլL	$V_{CC} = MAX$ ,	$V_{IL} = 0.4 V$				-0.2			-0.2	mA
l <sub>OS</sub> §	$V_{CC} = MAX$ ,			-40		-225	-40		-225	mA
		Outputs high	All		17	27		17	27	
	\\ \ MAX	Outputs low	'LS240		26	44		26	44	
lcc	V <sub>CC</sub> = MAX, Output open	Outputs low	'LS241, 'LS244		27	46		27	46	mA
		Outputs disabled	'LS240		29	50		29	50	
		Outputs disabled	'LS241, 'LS244		32	54		32	54	

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

# switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$ (see Figure 1)

PARAMETER	TEST CONDITIONS		'LS240			'LS241, 'LS244			UNIT
PARAMETER	1231 001	TEST CONDITIONS		TYP	MAX	MIN	TYP	MAX	UNIT
t <sub>PLH</sub>	R <sub>L</sub> = 667 Ω,	0 45 = 5		9	14		12	18	ns
<sup>t</sup> PHL	N_ = 007 22,	$C_L = 45 pF$		12	18		12	18	115
t <sub>PZL</sub>	R <sub>L</sub> = 667 Ω,	0. 45.5		20	30		20	30	ns
<sup>t</sup> PZH	N_ = 007 22,	C <sub>L</sub> = 45 pF		15	23		15	23	115
<sup>t</sup> PLZ	R <sub>L</sub> = 667 Ω,	C <sub>I</sub> = 5 pF		10	20		10	20	ns
<sup>t</sup> PHZ	NL = 007 22,	OL = 5 pr		15	25		15	25	115

 $<sup>\</sup>stackrel{+}{\sim}$  All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

<sup>§</sup> Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

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### recommended operating conditions

			SN54S'			SN74S'		UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage (see Note 1)	4.5	5	5.5	4.75	5	5.25	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.8			8.0	V
ЮН	High-level output current			-12			-15	mA
loL	Low-level output current			48			64	mA
	External resistance between any input and V <sub>CC</sub> or ground			40			40	kΩ
T <sub>A</sub>	Operating free-air temperature (see Note 3)	-55		125	0		70	°C

NOTES: 1. Voltage values are with respect to network ground terminal.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

24244555			.1		SN54S'			SN74S'		
PARAMETER		TEST CONDITIONS	ST	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIK	V <sub>CC</sub> = MIN,	I <sub>I</sub> = -18 mA				-1.2			-1.2	V
Hysteresis (V <sub>T+</sub> – V <sub>T</sub> –)	V <sub>CC</sub> = MIN			0.2	0.4		0.2	0.4		٧
	$V_{CC} = MIN$ $I_{OH} = -1 \text{ mA}$	V <sub>IH</sub> = 2 V,	V <sub>IL</sub> = 0.8 V,				2.7			
VOH	$V_{CC} = MIN,$ $I_{OH} = -3 \text{ mA}$	V <sub>IH</sub> = 2 V,	V <sub>IL</sub> = 0.8 V,	2.4	3.4		2.4	3.4		V
	V <sub>CC</sub> = MIN, I <sub>OH</sub> = MAX	V <sub>IH</sub> = 2 V,	$V_{IL} = 0.5 V,$	2			2			
VOL	V <sub>CC</sub> = MIN, I <sub>OL</sub> = MAX	V <sub>IH</sub> = 2 V,	V <sub>IL</sub> = 0.8 V,			0.55			0.55	٧
lozh	V <sub>CC</sub> = MAX, V <sub>IL</sub> = 0.8 V	V <sub>IH</sub> = 2 V,	V <sub>O</sub> = 2.4 V			50			50	μА
lozL	V <sub>CC</sub> = MAX, V <sub>IL</sub> = 0.8 V	V <sub>IH</sub> = 2 V,	V <sub>O</sub> = 0.5 V			<b>–</b> 50			-50	μА
lį	$V_{CC} = MAX$ ,	V <sub>I</sub> = 5.5 V				1			1	mA
lіН	$V_{CC} = MAX$ ,	V <sub>I</sub> = 2.7 V				50			50	μΑ
IIL	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 0.5 V	Any A			-400			-400	μΑ
	VCC = WAX,	V  = 0.5 V	Any G			-2			-2	mA
I <sub>OS</sub> §	$V_{CC} = MAX$			-50		-225	-50		-225	mA
		Outputs high	'S240		80	123		80	135	
		Outputs riigir	'S241,'S244		95	147		95	160	
loo	$V_{CC} = MAX$ ,	Outputs low	'S240		100	145		100	150	mA
lcc	Output open	Outputs low	'S241, 'S244		120	170		120	180	шА
		Outputs disabled	'S240		100	145		100	150	
		Culputs disabled	'S241, 'S244		120	170		120	180	

For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



An SN54S241J operating at free-air temperature above 116°C requires a heat sink that provides a thermal resistance from case to free air, R<sub>θCA</sub>, of not more that 40°C/W.

<sup>‡</sup> All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

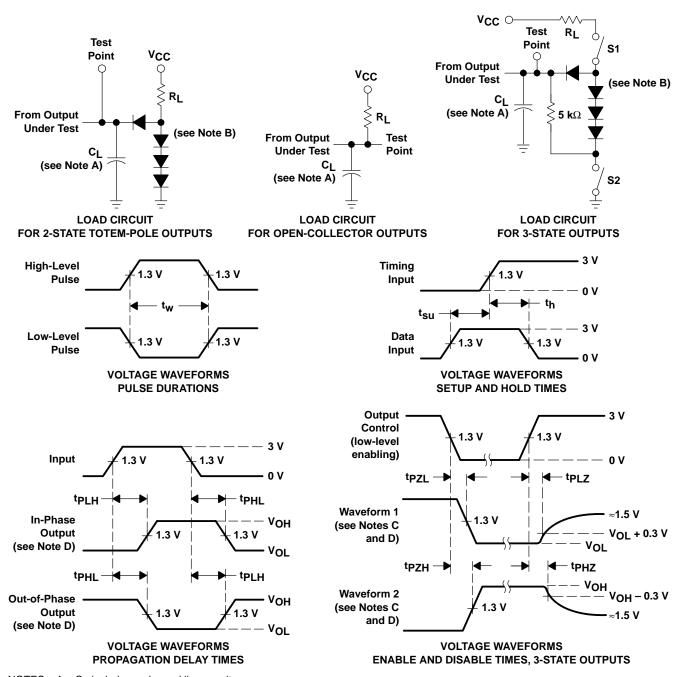
Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

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# switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ}\text{C}$ (see Figure 2)

PARAMETER	TEST CO	'S240			'S241, 'S244			UNIT	
PARAMETER	1231 00	TEST CONDITIONS				MIN	TYP	MAX	UNII
t <sub>PLH</sub>	R <sub>1</sub> = 90 Ω,	0 50 -5		4.5	7		6	9	ns
<sup>t</sup> PHL	NC = 90 22,	C <sub>L</sub> = 50 pF		4.5	7		6	9	115
tPZL	$R_1 = 90 \Omega$ ,	O. 50 -5		10	15		10	15	ns
<sup>t</sup> PZH	NC = 90 32,	$C_L = 50 pF$		6.5	10		8	12	115
t <sub>PLZ</sub>	P 00 O	C 5 pE		10	15		10	15	ns
t <sub>PHZ</sub>	$R_L = 90 \Omega$ ,	$C_L = 5 pF$		6	9		6	9	115

# PARAMETER MEASUREMENT INFORMATION SERIES 54LS/74LS DEVICES

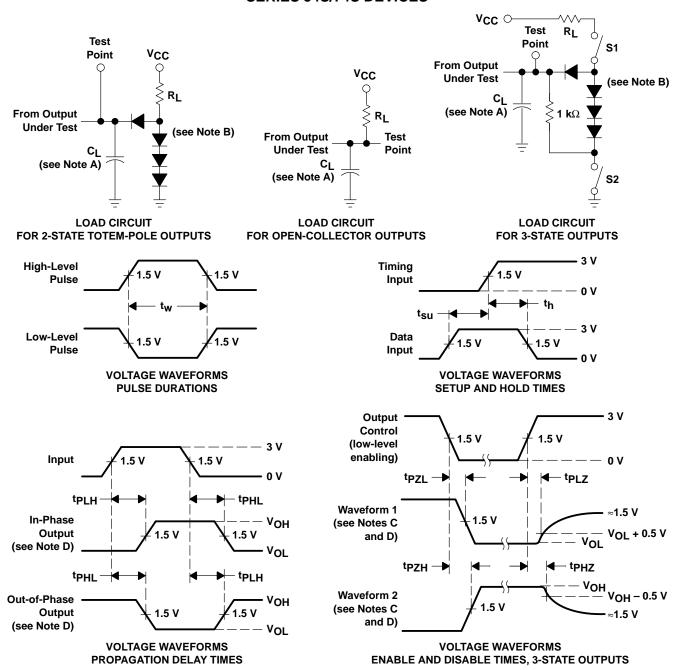


- NOTES: A.  $C_L$  includes probe and jig capacitance.
  - B. All diodes are 1N3064 or equivalent.
  - C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - D. S1 and S2 are closed for tpLH, tpHZ, and tpLZ; S1 is open and S2 is closed for tpZH; S1 is closed and S2 is open for tpZL.
  - E. Phase relationships between inputs and outputs have been chosen arbitrarily for these examples.
  - F. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O \approx 50 \Omega$ ,  $t_f \leq$  15 ns,  $t_f \leq$  6 ns.
  - G. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms



#### PARAMETER MEASUREMENT INFORMATION **SERIES 54S/74S DEVICES**

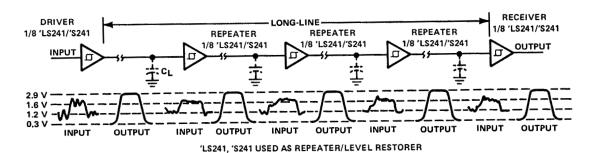


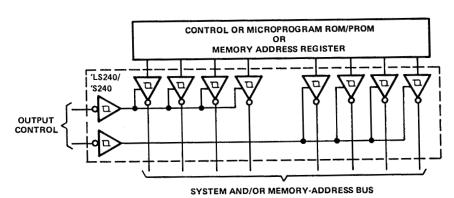
- NOTES: A. C<sub>I</sub> includes probe and jig capacitance.
  - B. All diodes are 1N3064 or equivalent.
  - C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
  - D. S1 and S2 are closed for tpLH, tpHL, tpHZ, and tpLZ; S1 is open and S2 is closed for tpZH; S1 is closed and S2 is open for tpZL.
  - E. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O \approx 50 \Omega$ ;  $t_r$  and  $t_f \leq$  7 ns for Series 54/74 devices and  $t_r$  and  $t_f \le 2.5$  ns for Series 54S/74S devices.
  - F. The outputs are measured one at a time with one input transition per measurement.

Figure 2. Load Circuits and Voltage Waveforms

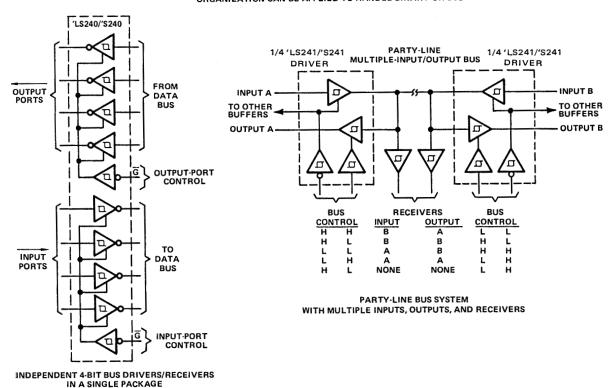


#### **APPLICATION INFORMATION**





'LS240/'S240 USED AS SYSTEM AND/OR MEMORY BUS DRIVER-4-BIT ORGANIZATION CAN BE APPLIED TO HANDLE BINARY OR BCD







com 28-Feb-2005

### **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
5962-7801201VRA	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
5962-7801201VSA	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC
7705701RA	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
7705701SA	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC
78012012A	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
7801201RA	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
7801201SA	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC
JM38510/32401B2A	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
JM38510/32401BRA	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
JM38510/32401BSA	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC
JM38510/32402B2A	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
JM38510/32402BRA	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
JM38510/32402BSA	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC
JM38510/32403B2A	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
JM38510/32403BRA	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
JM38510/32403BSA	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC
JM38510/32403SRA	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
JM38510/32403SSA	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC
SN54LS240J	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
SN54LS241J	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
SN54LS244J	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
SN54S240J	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
SN54S241J	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
SN54S244J	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
SN74LS240DW	ACTIVE	SOIC	DW	20	25	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74LS240DWR	ACTIVE	SOIC	DW	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74LS240J	OBSOLETE	CDIP	J	20		None	Call TI	Call TI
SN74LS240N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS240N3	OBSOLETE	PDIP	N	20		None	Call TI	Call TI
SN74LS240NSR	ACTIVE	SO	NS	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM
SN74LS241DW	ACTIVE	SOIC	DW	20	25	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74LS241DWR	ACTIVE	SOIC	DW	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR/ Level-1-235C-UNLIM
SN74LS241J	OBSOLETE	CDIP	J	20		None	Call TI	Call TI
SN74LS241N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS241N3	OBSOLETE	PDIP	N	20		None	Call TI	Call TI
SN74LS241NSR	ACTIVE	SO	NS	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR/ Level-1-235C-UNLIM





om 28-Feb-2005

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
SN74LS244DBR	ACTIVE	SSOP	DB	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
SN74LS244DW	ACTIVE	SOIC	DW	20	25	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR Level-1-235C-UNLIM
SN74LS244DWR	ACTIVE	SOIC	DW	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR Level-1-235C-UNLIM
SN74LS244J	OBSOLETE	CDIP	J	20		None	Call TI	Call TI
SN74LS244N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS244N3	OBSOLETE	PDIP	N	20		None	Call TI	Call TI
SN74LS244NSR	ACTIVE	SO	NS	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1 YEAR Level-1-235C-UNLIM
SN74S240DW	ACTIVE	SOIC	DW	20	25	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR Level-1-235C-UNLIM
SN74S240DWR	ACTIVE	SOIC	DW	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR Level-1-235C-UNLIM
SN74S240N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74S240N3	OBSOLETE	PDIP	N	20		None	Call TI	Call TI
SN74S241DW	ACTIVE	SOIC	DW	20	25	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR Level-1-235C-UNLIM
SN74S241DWR	ACTIVE	SOIC	DW	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR Level-1-235C-UNLIM
SN74S241J	OBSOLETE	CDIP	J	20		None	Call TI	Call TI
SN74S241N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74S241N3	OBSOLETE	PDIP	N	20		None	Call TI	Call TI
SN74S244DW	ACTIVE	SOIC	DW	20	25	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR Level-1-235C-UNLIM
SN74S244DWR	ACTIVE	SOIC	DW	20	2000	Pb-Free (RoHS)	CU NIPDAU	Level-2-250C-1 YEAR Level-1-235C-UNLIM
SN74S244J	OBSOLETE	CDIP	J	20		None	Call TI	Call TI
SN74S244N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74S244N3	OBSOLETE	PDIP	N	20		None	Call TI	Call TI
SNJ54LS240FK	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
SNJ54LS240J	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
SNJ54LS240W	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC
SNJ54LS241FK	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
SNJ54LS241J	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
SNJ54LS241W	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC
SNJ54LS244FK	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
SNJ54LS244J	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
SNJ54LS244W	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC
SNJ54S240FK	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
SNJ54S240J	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
SNJ54S240W	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC
SNJ54S241FK	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC



### PACKAGE OPTION ADDENDUM

28-Feb-2005

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)
SNJ54S241J	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
SNJ54S241W	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC
SNJ54S244FK	ACTIVE	LCCC	FK	20	1	None	Call TI	Level-NC-NC-NC
SNJ54S244J	ACTIVE	CDIP	J	20	1	None	Call TI	Level-NC-NC-NC
SNJ54S244W	ACTIVE	CFP	W	20	1	None	Call TI	Level-NC-NC-NC

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - May not be currently available - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

None: Not vet available Lead (Pb-Free).

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean "Pb-Free" and in addition, uses package materials that do not contain halogens, including bromine (Br) or antimony (Sb) above 0.1% of total product weight.

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDECindustry standard classifications, and peak solder temperature.

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